# **SZ-10N Series**



# **Data Sheet**

## **Description**

The SZ-10N series are power Zener diodes designed for the protection of automotive electronic units, especially from the surge generated during load dump conditions and voltage transients induced by inductive loads. The package of the IC has high dissipation and high surge capability.

#### **Features**

- AEC-Q101 Qualified
- Meets the Surge Protection Requirements in ISO7637-2 Standrard (Pulse 5a)
- T<sub>J</sub> = 175 °C Capability Suitable for High Reliability and Automotive Requirement
- High Surge Capability
- Flammability UL94V-0 (Equivalent)
- RoHS Compliant

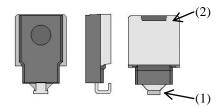
## **Applications**

Protection of sensitive electronic equipment in passenger cars, trucks, vans, and buses:

- Engine Control Units
- Electric Control Units
- Braking System
- Power Steering System
- Airbags
- Audio/Infotainment Equipment

# **Package**

SZ-10





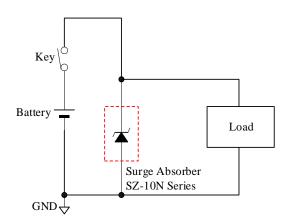
- (1) Cathode
- (2) Anode

Not to scale

# **Selection Guide**

Part Number	V	$I_{\rm Z}$	ī	D	
Part Number	Min.	Max.	$I_{RSM}$	$P_{D}$	
SZ-10N27	24 V	30 V	70 A	5 W	
SZ-10NN27	24 V		90 A	6 W	
SZ-10N40	36 V	44 V	45 A	5 W	
SZ-10NN40	30 V	44 V	70 A	6 W	

#### **Typical Application**



# **Contents**

Description1
Contents2
Absolute Maximum Ratings3
Electrical Characteristics4
SZ10N27 Rating and Characteristic Curves5
SZ10NN27 Rating and Characteristic Curves7
SZ10N40 Rating and Characteristic Curves9
SZ10NN40 Rating and Characteristic Curves
Physical Dimensions
Marking Diagram14
Important Notes15

## **Absolute Maximum Ratings**

Unless otherwise specified,  $T_A = 25$  °C.

Parameter	Symbol	Conditions	Rating	Unit	Remarks
Power Dissipation <sup>(1)</sup>	$P_{\mathrm{D}}$	Lead temperature <sup>(2)</sup>	5	W	SZ-10N27
					SZ-10N40
Tower Dissipation			6		SZ-10NN27
					SZ-10NN40
DC Blocking Voltage	$V_{DC}$	_	22	V	SZ-10N27
					SZ-10NN27
			32		SZ-10N40
					SZ-10NN40
Peak Surge Reverse Current	$I_{RSM}$	(3)	45	A	SZ-10N40
			70		SZ-10N27
					SZ-10NN40
			90		SZ-10NN27
Junction Temperature	$T_{J}$	_	−55 to 175	°C	
Storage Temperature	$T_{STG}$		-55 to 175	°C	

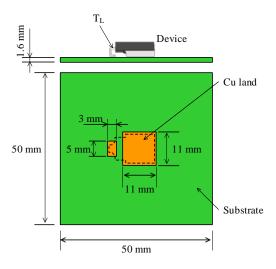


Figure 1. Lead Temperature Measurement Conditions

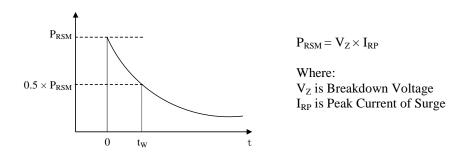


Figure 2. Definition of Peak Surge Reverse Current

<sup>(1)</sup> See Figure 3. (2) See Figure 1.

<sup>(3)</sup> See Figure 2.

## **SZ-10N Series**

## **Electrical Characteristics**

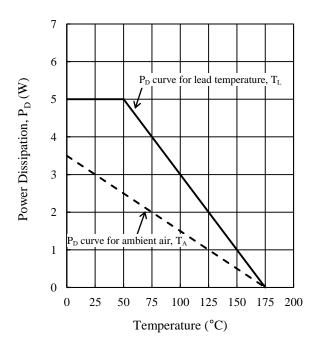
Unless otherwise specified,  $T_A = 25$  °C.

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	Remarks
Forward Voltage Drop V <sub>F</sub>		I <sub>F</sub> = 6 A			1.03	V	SZ-10N40
	$V_{\mathrm{F}}$			_	1.00		SZ-10N27
				—	0.98		SZ-10NN40
				—	0.95		SZ-10NN27
Reverse Leakage Current	$I_R$	$V_R = V_{DC}$			10	μΑ	
	V <sub>z</sub>	I <sub>Z</sub> = 10 mA	24		30 44	V	SZ-10N27
Breakdown Voltage							SZ-10NN27
			36	_			SZ-10N40
			30				SZ-10NN40
Breakdown Voltage Temperature Coefficient r <sub>Z</sub>		$I_Z = 10 \text{ mA}$	<u> </u>			SZ-10N27	
	r			22		mV/°C	SZ-10NN27
	re Coefficient		_	36	—		SZ-10N40
							SZ-10NN40
Breakdown Region Equivalent Resistance	$R_{Z}$	$I_Z = 1 A \text{ to } 10 A$	—	0.08		Ω	SZ-10N27
							SZ-10NN27
			_	0.1			SZ-10N40
							SZ-10NN40
Thermal Resistance	R <sub>th(j-L)</sub>	(4)	_	2.0	_	°C/W	

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 $<sup>^{(4)}</sup>$   $R_{th(j\text{-}c)}$  is thermal resistance between junction and lead. Lead temperature is measured as shown in Figure 1.

## SZ10N27 Rating and Characteristic Curves



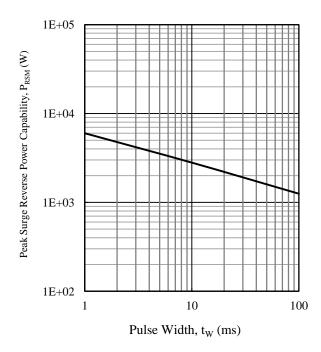


Figure 3. Power Dissipation Curves<sup>(5)</sup>

Figure 4. Peak Surge Reverse Power Capability<sup>(6)</sup>

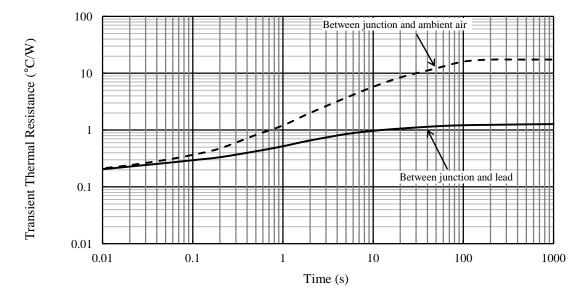


Figure 5. Typical Transient Thermal Resistance<sup>(7)</sup>

 $<sup>\</sup>overline{}^{(5)}$  See Figure 1 for the measurement conditions of the lead temperature.

<sup>(6)</sup> See Figure 2.

<sup>(7)</sup> See Figure 1 for the measurement conditions of the lead temperature.

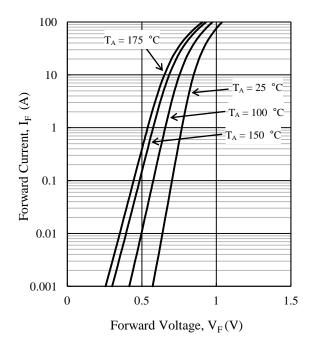


Figure 6. I<sub>F</sub> vs. V<sub>F</sub> Typical Characteristics

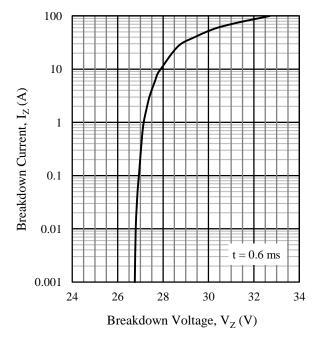


Figure 8. I<sub>Z</sub> vs. V<sub>Z</sub> Typical Characteristics

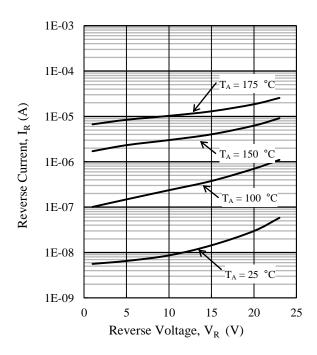
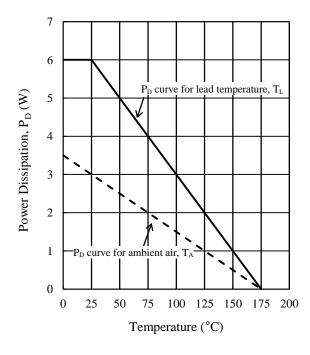


Figure 7.  $I_R$  vs.  $V_R$  Typical Characteristics

# SZ10NN27 Rating and Characteristic Curves



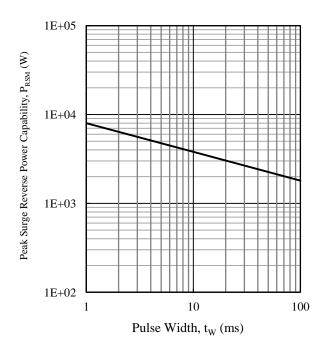


Figure 9. Power Dissipation Curves<sup>(8)</sup>

Figure 10. Peak Surge Reverse Power Capability<sup>(9)</sup>

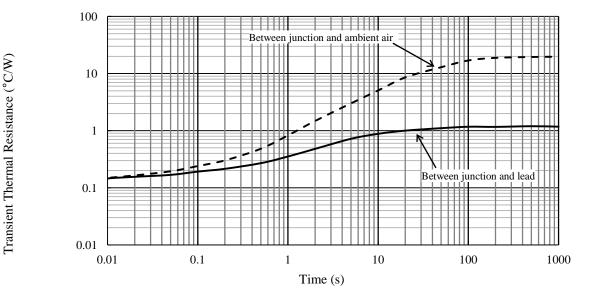


Figure 11. Typical Transient Thermal Resistance<sup>(10)</sup>

 $<sup>\</sup>overline{^{(8)}}$  See Figure 1 for the measurement conditions of the lead temperature.

<sup>(9)</sup> See Figure 2.

 $<sup>^{(10)}</sup>$  See Figure 1 for the measurement conditions of the lead temperature.

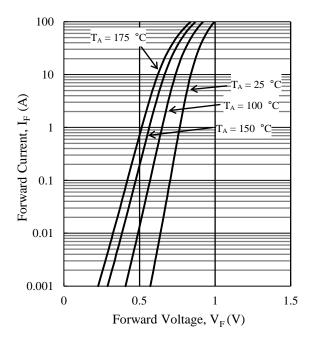


Figure 12. V<sub>F</sub> vs. I<sub>F</sub> Typical Characteristics

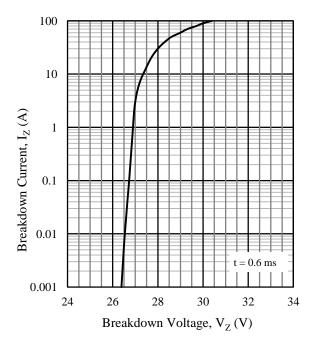


Figure 14. I<sub>Z</sub> vs. V<sub>Z</sub> Typical Characteristics

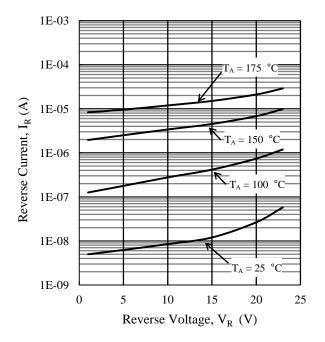
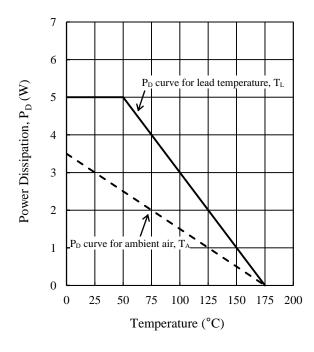


Figure 13.  $V_R$  vs.  $I_R$  Typical Characteristics

## SZ10N40 Rating and Characteristic Curves



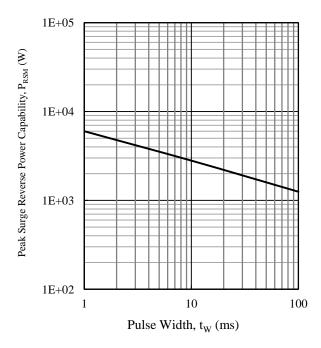


Figure 15. Power Dissipation Curves<sup>(11)</sup>

Figure 16. Peak Surge Reverse Power Capability<sup>(12)</sup>

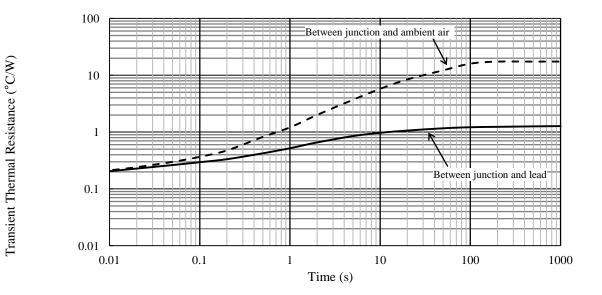


Figure 17. Typical Transient Thermal Resistance (13)

 $<sup>\</sup>overline{^{(11)}}$  See Figure 1 for the measurement conditions of the lead temperature.

<sup>(12)</sup> See Figure 2.

<sup>(13)</sup> See Figure 1 for the measurement conditions of the lead temperature.

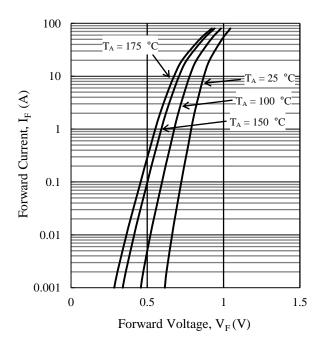


Figure 18. V<sub>F</sub> vs. I<sub>F</sub> Typical Characteristics

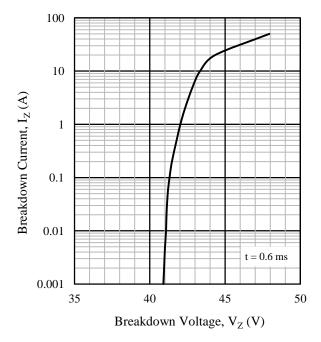


Figure 20. I<sub>Z</sub> vs. V<sub>Z</sub> Typical Characteristics

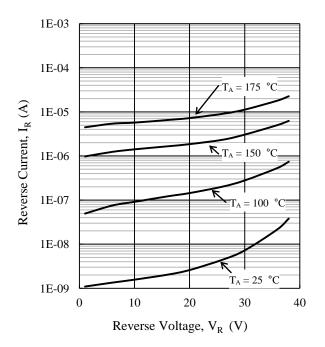
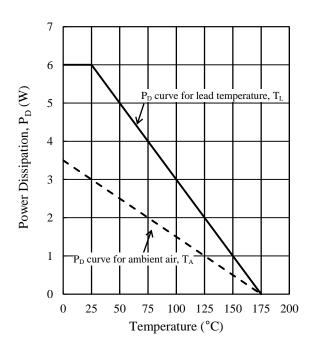


Figure 19.  $V_R$  vs.  $I_R$  Typical Characteristics

#### SZ10NN40 Rating and Characteristic Curves



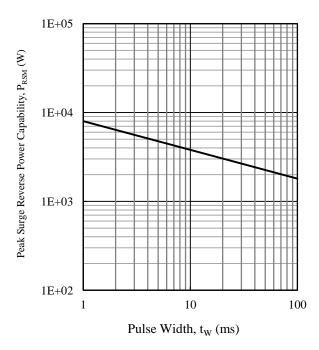


Figure 21. Power Dissipation Curves (14)

Figure 22. Peak Surge Reverse Power Capability<sup>(15)</sup>

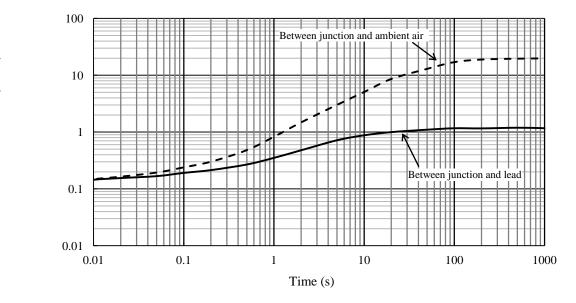


Figure 23. Typical Transient Thermal Resistance (16)

Fransient Thermal Resistance (°C/W)

 $<sup>\</sup>overline{^{(14)}}$  See Figure 1 for the measurement conditions of the lead temperature.

<sup>(15)</sup> See Figure 2.

<sup>(16)</sup> See Figure 1 for the measurement conditions of the lead temperature.

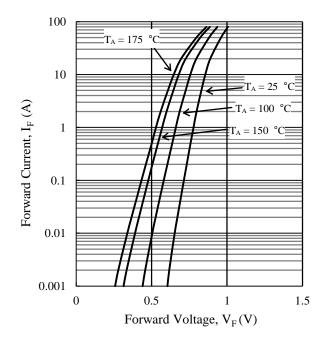


Figure 24. V<sub>F</sub> vs. I<sub>F</sub> Typical Characteristics

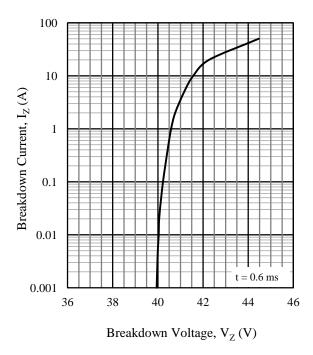


Figure 26. I<sub>Z</sub> vs. V<sub>Z</sub> Typical Characteristics

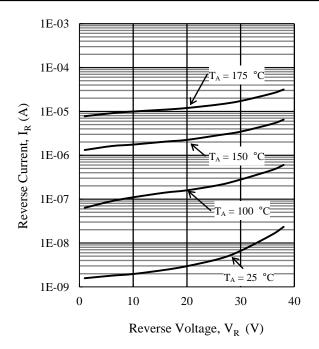
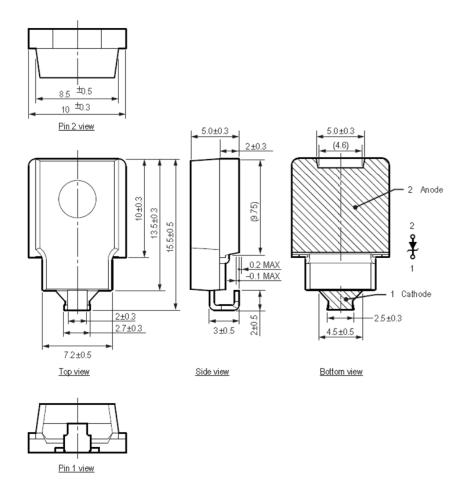


Figure 25. V<sub>R</sub> vs. I<sub>R</sub> Typical Characteristics

## **Physical Dimensions**

#### • SZ-10 Package



#### **NOTES:**

- Dimensions in millimeters
- Bare lead frame: Pb-free (RoHS compliant)
- When soldering the products, be sure to minimize the working time, within the following limits:

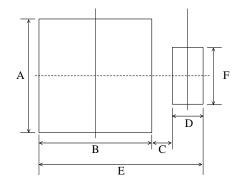
Reflow (MSL 3)

Preheat:  $180 \, ^{\circ}\text{C} / 90 \pm 30 \, \text{s}$ 

Solder heating:  $250 \, ^{\circ}\text{C} / 10 \pm 1\text{s}$ , 2 times (260  $^{\circ}\text{C}$  peak)

Soldering iron:  $380 \pm 10$  °C /  $3.5 \pm 0.5$  s, 1 time

#### • SZ-10 Land Pattern Example



Sumbol	Dimensions (mm)			
Symbol	Min.	Max.		
A	10.8	11.2		
В	10.8	11.2		
С	2.4	2.6		
D	3.1	3.5		
Е	16.5	17.1		
F	5.3	5.7		

## **Marking Diagram**

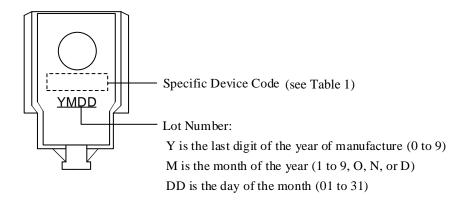


Table 1. Specific Device Code

Specific Device Code	Part Number		
BN27	SZ-10N27		
BN40	SZ-10N40		
DN27	SZ-10NN27		
DN40	SZ-10NN40		

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